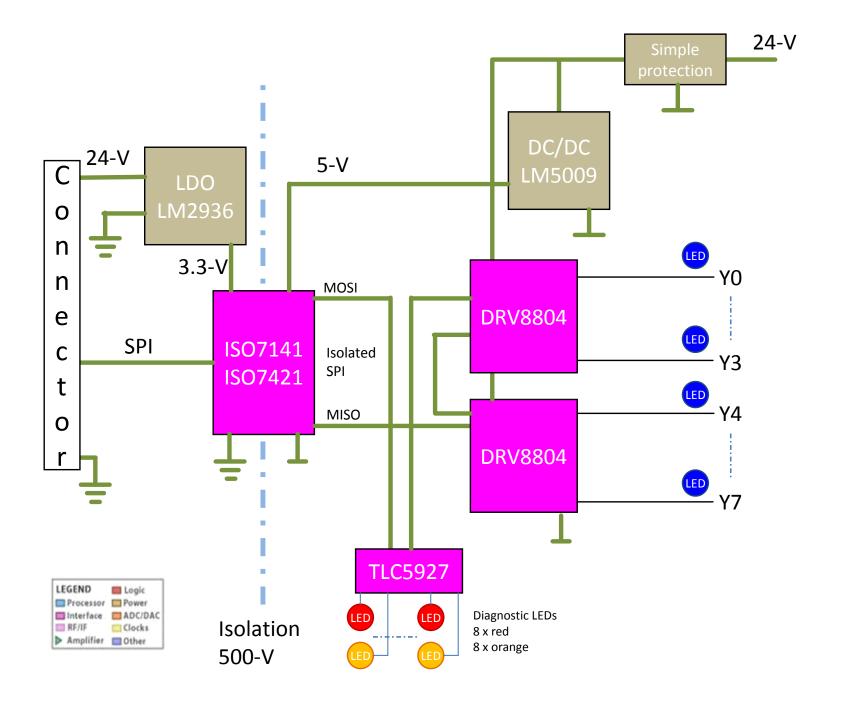
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Block diagram

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Designed for: Public Release | Mod. Date: 9/11/2014 | Project Title: TIDA-00236 8-Ch 0.5A Low Side O/P for PLC

Number: TIDA-00236 Rev: E1 Sheet Title: Block diagram

SVN Rev: Not in version control Assembly Variant: 001

Drawn By:Ingolf Frank File: Pg2 Block Diagram.SchDoc

Engineer: Ingolf Frank Contact: http://www.ti.com/support

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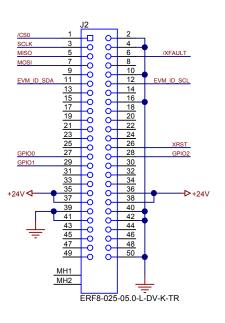
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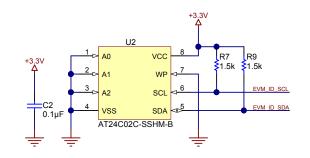
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Connectors

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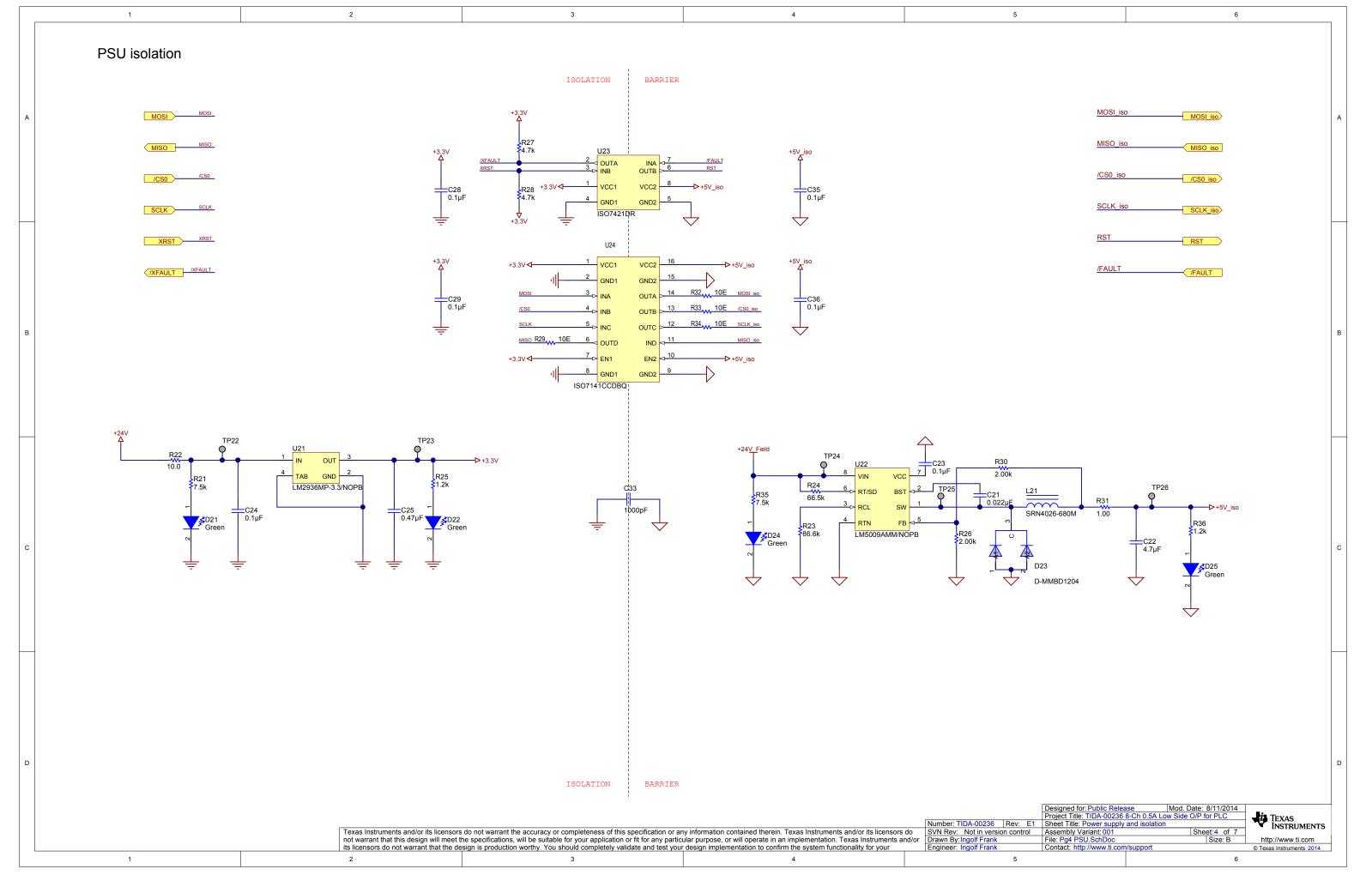
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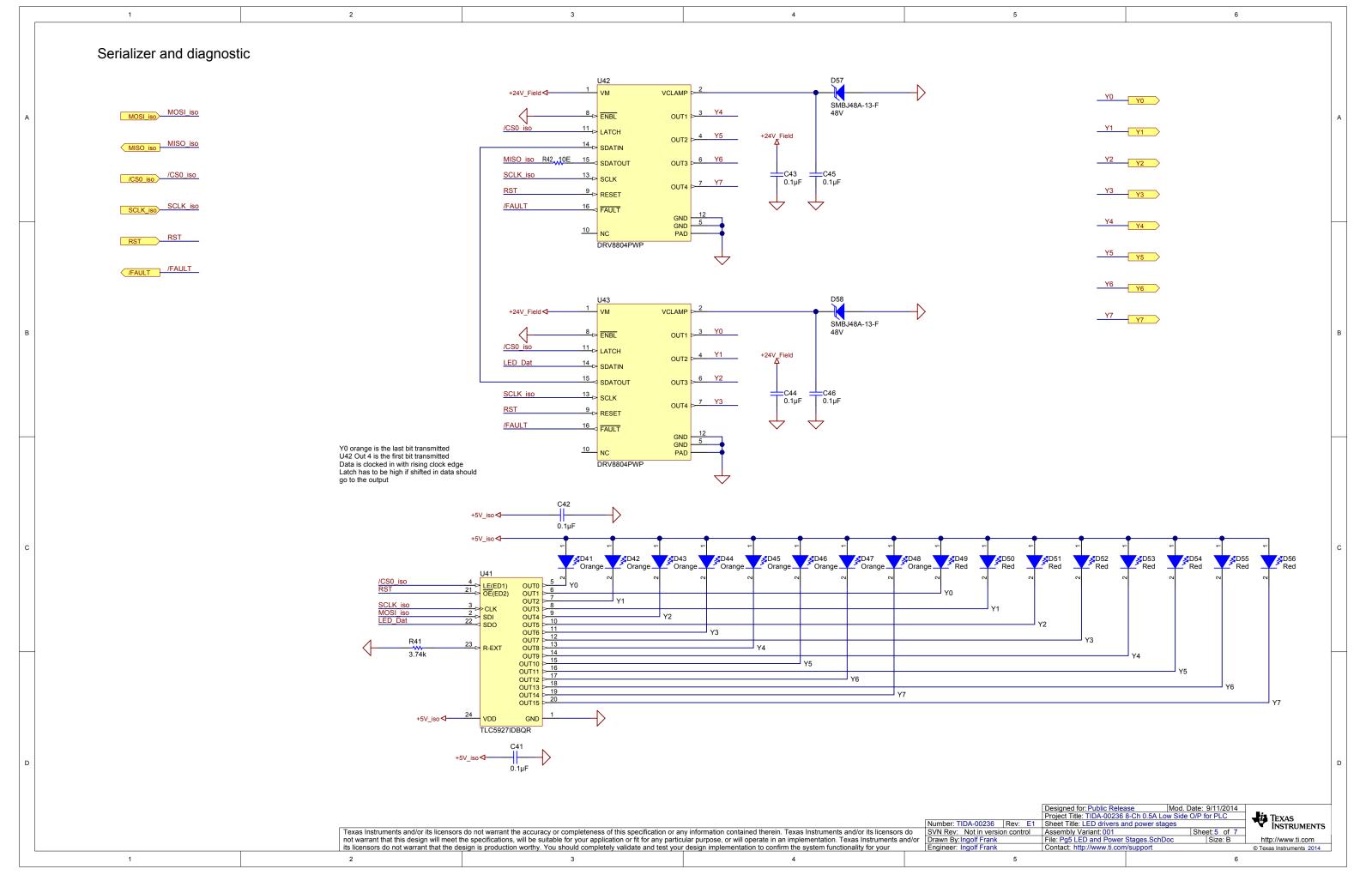
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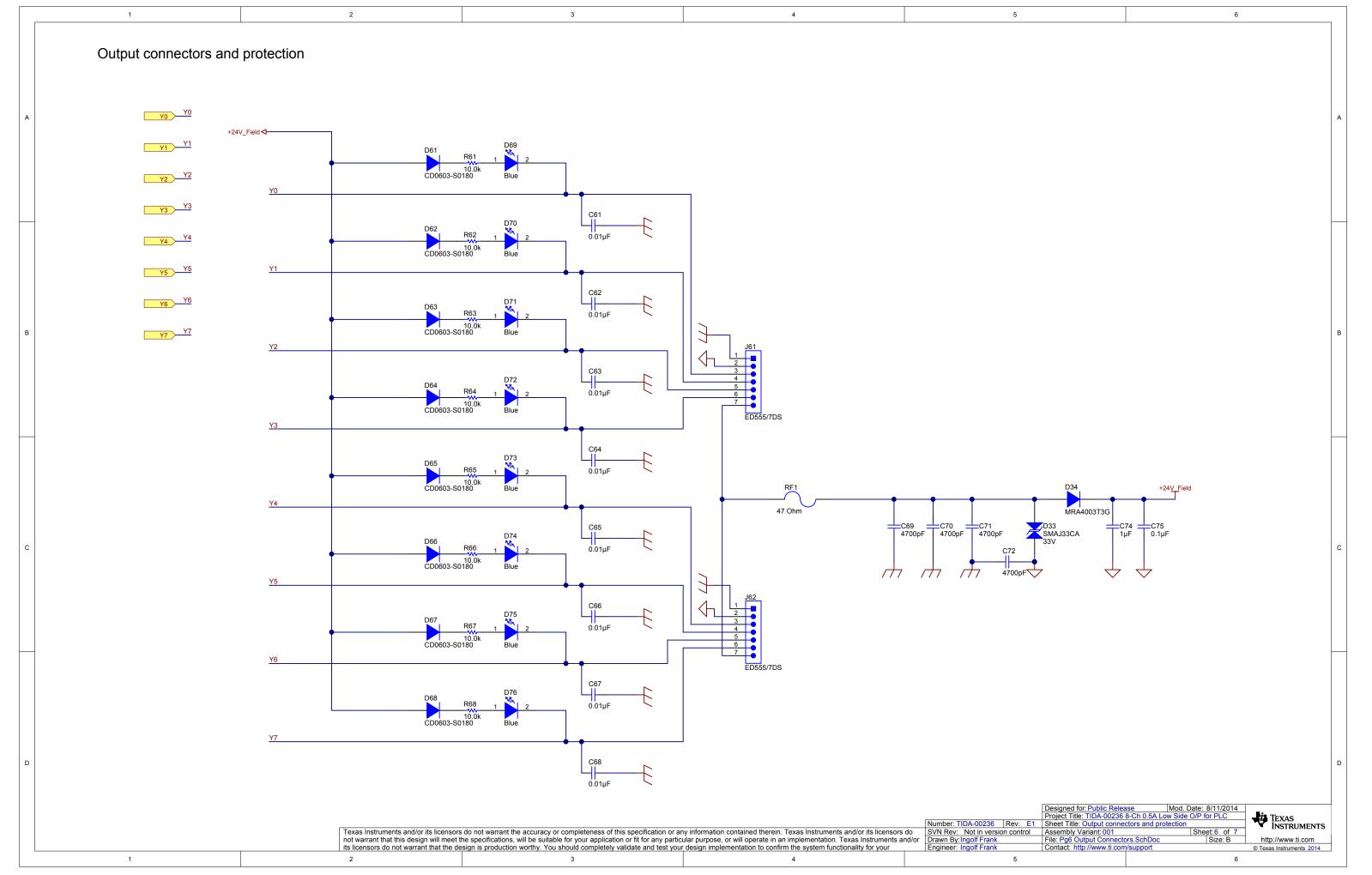
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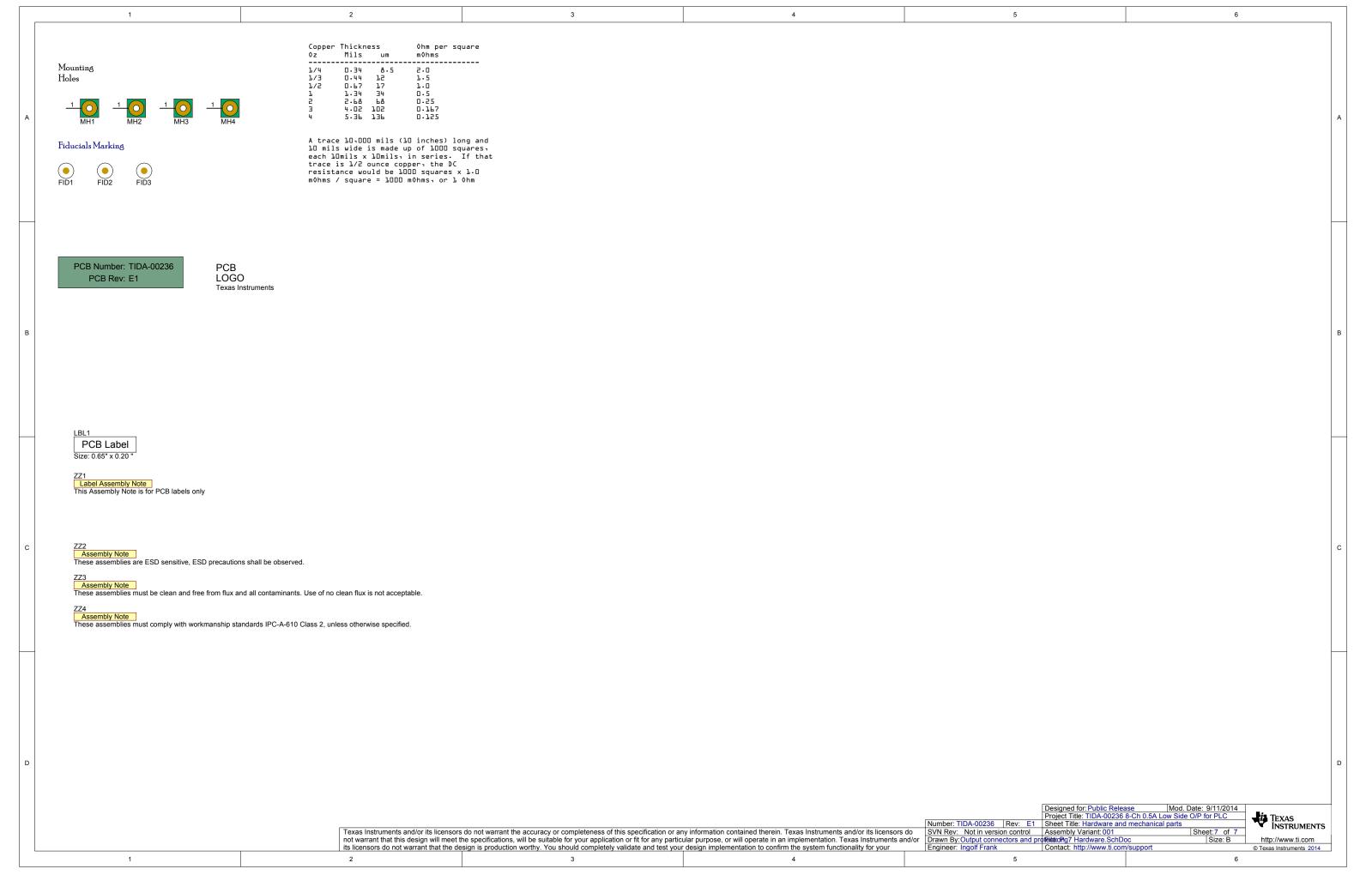
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